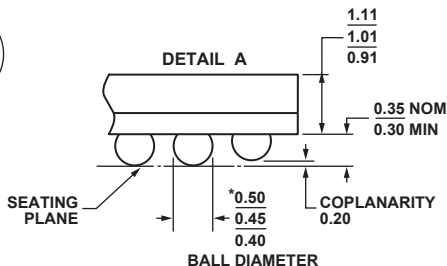
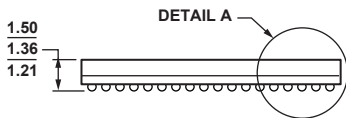
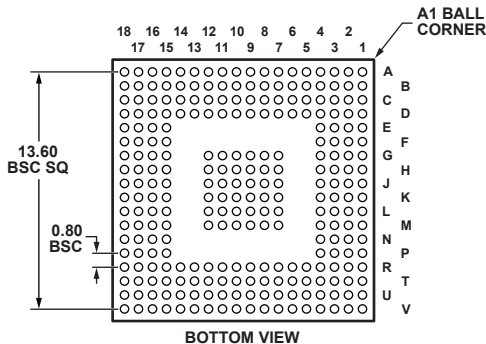
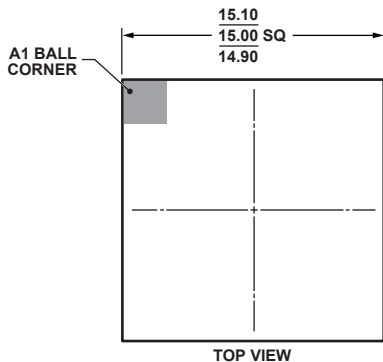


**260-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-260-1)**

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-205-AG WITH THE EXCEPTION TO BALL DIAMETER.